Si4155DY

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Vishay Siliconix

P-Channel 30 V (D-S) MOSFET



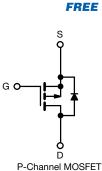
PRODUCT SUMMARY				
V _{DS} (V)	-30			
$R_{DS(on)}$ max. (Ω) at V_{GS} = -10 V	0.0150			
$R_{DS(on)}$ max. (Ω) at V_{GS} = -4.5 V	0.0260			
Q _g typ. (nC)	16			
I _D (A)	-13.6 °			
Configuration	Single			

FEATURES

- TrenchFET® power MOSFET
- 100 % $R_{\rm q}$ and UIS tested
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Notebook computers and mobile computing
- Adaptor switch / load switch
- Battery management
- Power management



RoHS

COMPLIANT

HALOGEN

ORDERING INFORMATION			
Package	SO-8		
Lead (Pb)-free and halogen-free	Si4155DY-T1-GE3		

PARAMETER	SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	-30	V
Gate-source voltage		V _{GS}	± 25	
Continuous drain current (T _J = 150 °C)	T _C = 25 °C		-13.6	
	T _C = 70 °C		-10.9	
	T _A = 25 °C	I _D	-10.2 ^{a,b}	
	T _A = 70 °C		-8.2 ^{a,b}	•
Pulsed drain current (t = 100 μs)		I _{DM}	-50	— A
Continuous source-drain diode current	T _C = 25 °C		3.7	
	T _A = 25 °C	I _S	-2.1 ^{a,b}	
Avalanche current		I _{AS}	-14	
Single-pulse avalanche energy	L = 0.1 mH	E _{AS}	9.8	mJ
Maximum power dissipation	T _C = 25 °C		4.5	
	T _C = 70 °C		2.9	14/
	T _A = 25 °C	- P _D	2.5 ^{a,b}	W
	T _A = 70 °C	1	1.6 ^{a,b}	
Operating junction and storage temperature range	T _J , T _{stq}	-50 to 150	°C	

Notes

- a. Surface mounted on 1" x 1" FR4 board
- b. t = 10 s
- c. T_C = 25 °C

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THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum junction to ambient ^{a,b}	t ≤ 10 s	R _{thJA}	38	50	°C/W	
Maximum junction to case (drain)	Steady State	R _{thJC}	22	28		

Notes

a. Surface mounted on 1" x 1" FR4 board

b. Maximum under steady state conditions is 85 °C/W

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static		·					
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = -250 \mu\text{A}$	-30	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	L 050	-	-23	-	mV/°C	
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = -250 μA	-	4.8	-		
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = -250 \ \mu A$	-1.2	-	-2.5	V	
Gate-source leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 25 V$	-	-	± 100	nA	
Zava gata valtaga dvaja avvent		$V_{DS} = -30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	-1		
Zero gate voltage drain current	I _{DSS}	$V_{DS} = -30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 ^{\circ}\text{C}$	-	-	-10	μA	
Drain-source on-state resistance ^a	Р	$V_{GS} = -10 \text{ V}, \text{ I}_{D} = -7 \text{ A}$	-	0.0125	0.0150	Ω	
	R _{DS(on)}	$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -3 \text{ A}$	-	0.0210	0.0260		
Forward transconductance ^a	9 _{fs}	V _{DS} = -15 V, I _D = -7 A	-	52	-	S	
Dynamic ^b	•	·				•	
Input capacitance	C _{iss}		-	1870	-	pF	
Output capacitance	C _{oss}	$V_{DS} = -15 \text{ V}, V_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$	-	245	-		
Reverse transfer capacitance	C _{rss}		-	212	-		
Tatal asta sharra	0	$V_{DS} = -15 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -12 \text{ A}$	-	33	50	nC	
Total gate charge	Qg		-	16	25		
Gate-source charge	Q _{gs}	$V_{DS} = -15 \text{ V}, \text{ V}_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -12 \text{ A}$	-	5.6	-		
Gate-drain charge	Q _{gd}		-	5.5	-		
Gate resistance	Rg	f = 1 MHz	0.64	3.2	6.4	Ω	
Turn-on delay time	t _{d(on)}		-	38	57	-	
Rise time	t _r	$V_{DD} = -15 \text{ V}, \text{ R}_{\text{I}} = 1.6 \Omega$	-	34	51		
Turn-off delay time	t _{d(off)}	$I_D \cong -9.6$ Å, $V_{GEN} = -4.5$ V, $R_g = 1$ Ω	-	24	36		
Fall time	t _f		-	10	20		
Turn-on delay time	t _{d(on)}		-	8	16	ns	
Rise time	t _r	$V_{DD} = -15 \text{ V}, \text{ R}_{\text{L}} = 1.6 \Omega$	-	9	18	-	
Turn-off delay time	t _{d(off)}	$I_D \cong -9.6$ A, $V_{GEN} = -10$ V, $R_g = 1$ Ω	-	22	33		
Fall time	t _f		-	7	14		
Drain-Source Body Diode Characteris	tics	•		•		•	
Continuous source-drain diode current	Is	T _C = 25 °C		-	-18 ^c	•	
Pulse diode forward current ^d	I _{SM}		-	-	-50	A	
Body diode voltage	V _{SD}	I _F = -9.6 A	-	-0.8	-1.2	V	
Body diode reverse recovery time	t _{rr}		-	21	32	ns	
Body diode reverse recovery charge	Q _{rr}		-	12	20	nC	
Reverse recovery fall time	t _a	$I_F = -9.6 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, \text{ T}_J = 25 ^\circ\text{C}$	-	11	-		
Reverse recovery rise time	t _b	1	-	10	-	ns	

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

b. Guaranteed by design, not subject to production testing

c. Package limited

d. t = 100 µs

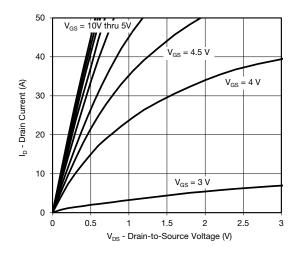
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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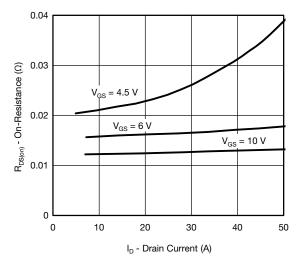
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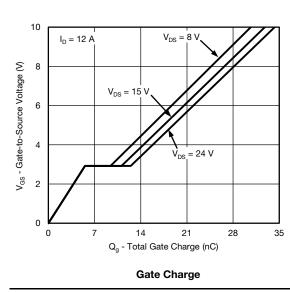
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Output Characteristics

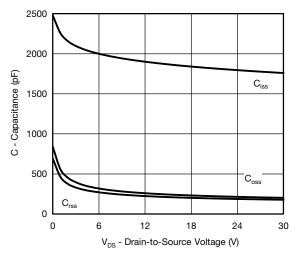


On-Resistance vs. Drain Current and Gate Voltage

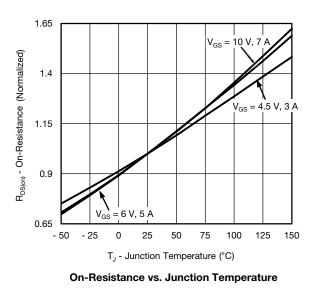


5 4 l_D - Drain Current (A) 3 T_C = 25 °C 2 1 = 125Г_с = - 55 °С 0 0 1 2 3 4 V_{GS} - Gate-to-Source Voltage (V)

Transfer Characteristics







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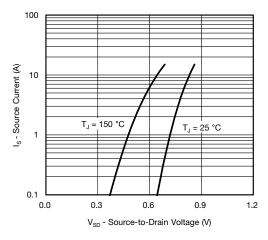
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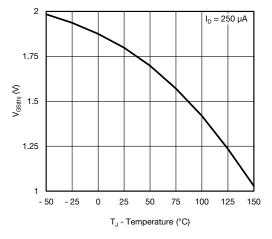
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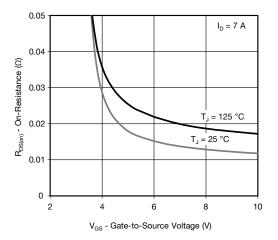
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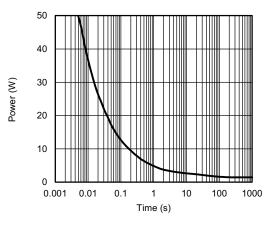
Source-Drain Diode Forward Voltage



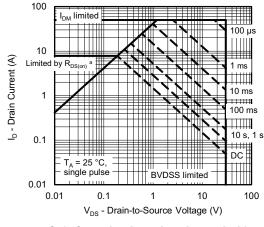
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



Safe Operating Area, Junction-to-Ambient

Note

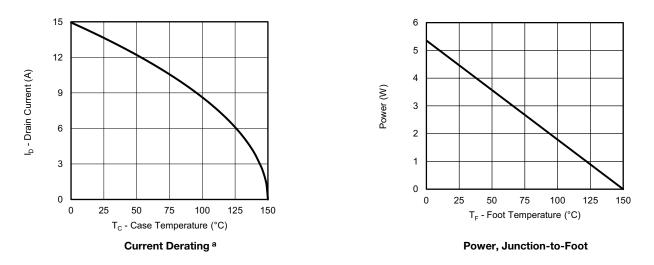
a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



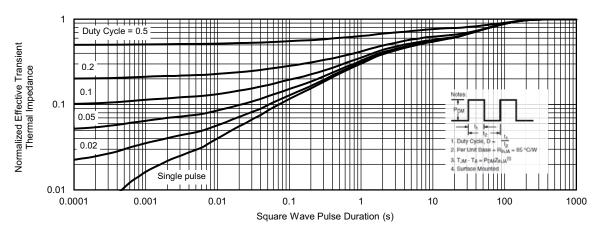
Note

a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit

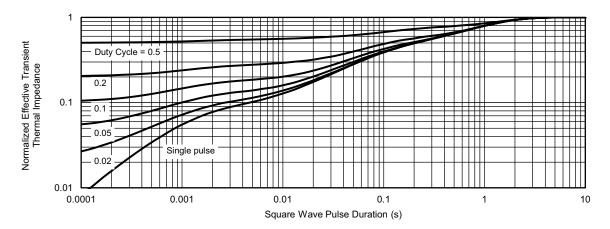


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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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